

Vishay General Semiconductor

Surface Mount Trench MOS Barrier Schottky Rectifier



DO-214AA (SMB)

| PRIMARY CHARACTERISTICS | | | |
|--|----------------|--|--|
| Package | DO-214AA (SMB) | | |
| I _{F(AV)} | 4.0 A | | |
| V _{RRM} | 100 V | | |
| I _{FSM} | 80 A | | |
| E _{AS} | 50 mJ | | |
| V _F at I _F = 4.0 A | 0.61 V | | |
| T _J max. | 150 °C | | |
| Diode variations | Single die | | |

FEATURES

- Low profile package
- · Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 2 whisker test **Polarity:** Color band denotes the cathode end

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | |
|---|-----------------------------------|-------------|------|--|
| PARAMETER | SYMBOL | VSSB410S | UNIT | |
| Device marking code | | V4B | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 100 | V | |
| Maximum DC forward current | I _F ⁽¹⁾ | 4.0 | | |
| | I _F ⁽²⁾ | 1.9 | Α | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I _{FSM} | 80 | А | |
| Non-repetitive avalanche energy at T _J = 25 °C, L = 60 mH | E _{AS} | 50 | mJ | |
| Peak repetitive reverse current at t_p = 2 μ s, 1 kHz, T_J = 38 °C \pm 2 °C | I _{RRM} | 1.0 | А | |
| Operating junction and storage temperature range | T _J , T _{STG} | -40 to +150 | °C | |

Notes

- (1) Mounted on 14 mm x 14 mm pad areas, 1 oz. FR4 PCB
- (2) Free air, mounted on recommended copper pad area



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|--|-------------------------|-------------------------------|---------------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Breakdown voltage | I _R = 1.0 mA | T _A = 25 °C | V_{BR} | 100 (minimum) | - | V |
| Instantaneous forward voltage | $I_F = 4.0 \text{ A}$ $T_A = 25 \text{ °C}$ $T_A = 125 \text{ °C}$ | T _A = 25 °C | V _F ⁽¹⁾ | 0.68 | 0.77 | V |
| | | T _A = 125 °C | | 0.61 | 0.69 | |
| Reverse current | V _R = 70 V | T _A = 25 °C | I _R ⁽²⁾ | 1.5 | - | μA |
| | | T _A = 125 °C | | 1.2 | - | mA |
| | $V_{\rm P} = 100 \text{ V}$ | T _A = 25 °C | | 7.0 | 250 | μA |
| | | T _A = 125 °C | | 3.6 | 20 | mA |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 230 | = | pF |

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | |
|---|----------------------|----------|------|--|
| PARAMETER SY | | VSSB410S | UNIT | |
| Typical thermal resistance | R _{0JA} (1) | 120 | °C/W | |
| | R _{0JM} (2) | 15 | C/VV | |

Notes

- $^{(1)}$ Free air, mounted on recommended PCB 1 oz. pad area. Thermal resistance $R_{\theta JA}$ junction to ambient
- Units mounted on PCB with 14 mm x 14 mm copper pad areas. $R_{\theta JM}$ junction to mount

| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|--|-----|---------------|------------------------------------|--|
| PREFERRED P/N | PREFERRED P/N UNIT WEIGHT (g) PREFERRED PACKAGE CODE | | BASE QUANTITY | DELIVERY MODE | |
| VSSB410S-E3/52T | 0.096 | 52T | 750 | 7" diameter plastic tape and reel | |
| VSSB410S-E3/5BT | 0.096 | 5BT | 3200 | 13" diameter plastic tape and reel | |

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

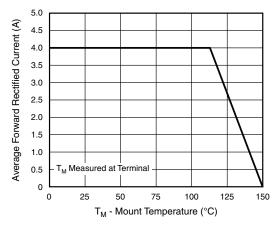


Fig. 1 - Maximum Forward Current Derating Curve

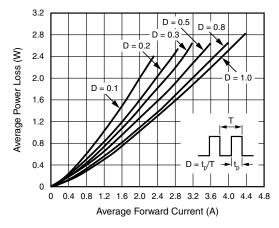


Fig. 2 - Forward Power Loss Characteristics



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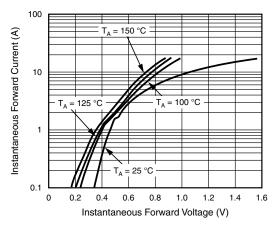


Fig. 3 - Typical Instantaneous Forward Characteristics

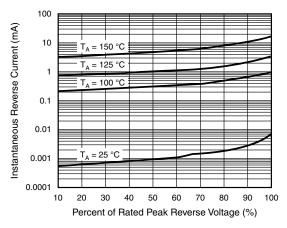


Fig. 4 - Typical Reverse Characteristics

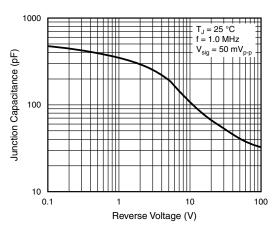


Fig. 5 - Typical Junction Capacitance

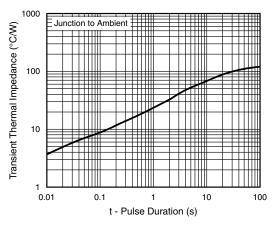
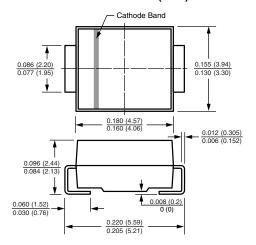


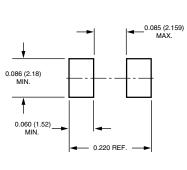
Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AA (SMB)



Mounting Pad Layout





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